

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	"20070098995"	US-PGPUB; USPAT	ADJ	ON	2008/03/21 10:03
L2	1	1 and (flow near1 amount)	US-PGPUB; USPAT	ADJ	ON	2008/03/21 10:03
L3	1	1 and solid	US-PGPUB; USPAT	ADJ	ON	2008/03/21 11:09
L4	1	("5773509").PN.	USPAT	OR	OFF	2008/03/21 11:17
L5	1	4 and solid	US-PGPUB; USPAT	ADJ	ON	2008/03/21 11:17
L6	1	4 and epoxy	US-PGPUB; USPAT	ADJ	ON	2008/03/21 11:17
L7	0	1 and ECON	US-PGPUB; USPAT	ADJ	ON	2008/03/21 11:18
L8	907002	adhesive or glue or binder	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:38
L9	348016	epoxy or epoxide	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:39
L10	142269	polyimide	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:39
L11	714827	semiconductor	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:39
L12	9915	8 same 9 same 10	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:39
L13	5897	8 with 9 with 10	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:39
L14	345	13 with 11	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:39
L15	118196	(solubility near1 parameter) or "SP"	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:40
L16	10	14 and 15	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:40
L17	318	escn or (escn near1 "195")	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:42
L18	6	14 and 17	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:42
L19	582	525/423.ccls.	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:47
L20	273	19 and (adhesive or glue)	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:48
L21	107	20 and (polyimide or imide)	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:49

L22	188	19 and (polyimide or imide)	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:50
L23	177	22 and (epoxide or epoxy)	US-PGPUB; USPAT	ADJ	ON	2008/03/21 12:50
S1	1	"20070098995"	US-PGPUB; USPAT	ADJ	ON	2008/03/19 16:46
S2	1	("5773509").PN.	USPAT	OR	OFF	2008/03/20 11:30
S3	404302	tri or tetra	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:14
S4	1060308	functional or functionality	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:14
S5	11889	S3 with S4	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:14
S6	6338	phenol near2 novolak	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:14
S7	41	S5 same S6	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:15
S8	118457	SP or (solubility near2 parameter)	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:18
S9	0	S8 and S2	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:19
S10	8229	tan delta	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:20
S11	0	S10 and S2	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:20
S12	1	"tan.delta."	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:21
S13	1514	"tan.delta"	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:21
S14	1	"20070098995"	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:21
S15	0	S13 and S14	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:21
S16	0	S2 and "tan"	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:22
S17	0	S14 and sumitomo	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:39
S18	52	pr near1 ("50781" or "175" or "53647" or "22193")	US-PGPUB; USPAT	ADJ	ON	2008/03/20 12:42
S19	1	S2 and filler	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:15
S20	199021	epoxy with (resin or adhesive or glue or binder)	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:35

S21	104000	((curing or crosslinking) near1 agent\$1) or curative	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:36
S22	31969	naphthol or trisphenol or tetrakisphenol	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:36
S23	186	S21 with S22	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:37
S24	176	S20 and S23	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:37
S25	41	S24 and polyimide	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:37
S26	324	(naphthol near1 novolak) or (trisphenol near1 novolak) or tetrakisphenol	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:48
S27	30	S21 with S26	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:48
S28	30	S27 and S20	US-PGPUB; USPAT	ADJ	ON	2008/03/20 14:48
S29	37	masuko same takashi	US-PGPUB; USPAT	ADJ	ON	2008/03/20 17:37
S30	3	ookubo same keisuke	US-PGPUB; USPAT	ADJ	ON	2008/03/20 17:38
S31	10	hatakeyama same keiichi	US-PGPUB; USPAT	ADJ	ON	2008/03/20 17:38
S32	40	yusa same masami	US-PGPUB; USPAT	ADJ	ON	2008/03/20 17:38
S33	72	S29 or S30 or S31 or S32	US-PGPUB; USPAT	ADJ	ON	2008/03/20 17:38
S34	47	S33 and (epoxy or polyimide or imide or epoxide)	US-PGPUB; USPAT	ADJ	ON	2008/03/20 17:39
S35	128	masuko same takashi	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:04
S36	4	ookubo same keisuke	FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:05
S37	38	hatakeyama same keiichi	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:05
S38	244	yusa same masami	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:05

S39	376	S35 or S36 or S37 or S38	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:05
S40	355988	epoxy or epoxide or imide or polyimide	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:06
S41	142	S39 and S40	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/03/20 18:06

3/ 21/ 2008 1:06:33 PM

C:\Documents and Settings\adesai1\My Documents\EAST\Workspaces\Searches\10560073.wsp